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A¹ is the height of each ^{said} first electrode, B¹ is the width of each ^{said} first electrode, C¹ is the width of the interelectrode space for the first electrodes, A² is the height of each ^{said} second electrode, B² is the width of each ^{said} second electrode, C² is the width of the interelectrode space for the second electrodes (provided that $B + C = B^1 + C^1 = B^2 + C^2$), and X is the thickness of the electroconductive adhesive layer prior to connection.

REMARKS

Claim 2 is pending. By this Preliminary Amendment, the Title and claim 2 are amended. No new matter is added. The amendments are not believed to narrow the scope of claim 2.

The attached Appendix includes a marked-up copy of the rewritten claim (37 C.F.R. 1.121(c)(1)(ii)).

Prompt and favorable examination on the merits is respectfully requested.

Respectfully submitted,

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APPENDIX

Changes to Title:

The following is a marked-up version of the amended title:

~~CONNECTION STRUCTURE~~METHOD FOR CONNECTING ELECTRICAL
COMPONENTS

Changes to Claims:

The following is a marked-up version of the amended claim:

2. (Amended) A connection method, comprising:

for electrically connecting first electrodes on a first substrate and second electrodes on a second substrate with an interposed anisotropic electroconductive adhesive layer, wherein said connection method satisfies Eq. 1 below the thickness of the electroconductive adhesive layer prior to connection is given by:

$$0.5 \times \{(A^1 C^1 + A^2 C^2) / (B + C)\} \leq X \leq 2 \times \{(A^1 C^1 + A^2 C^2) / (B + C)\} \text{ ——— (1)}$$

where:

-A¹ is the height of each first electrode, B¹ is the electrode width thereof, C¹ is the width of the interelectrode space, A² is the height of each second electrode, B² is the electrode width thereof, C² is the of the interelectrode space (provided that B + C = B¹ + C¹ = B² + C²), and X is the thickness of the electroconductive adhesive layer prior to connection.